FORM PTO-1595 Recordation Form (Rev. 10/02) Recordation Form (Rev. 10/02) PATENTS	Data ut and Tandanasel: Office
To the Honorable Commissioner of Patents and Trademarks. Please re 1. Name of conveying party(les): Hee-Bok Kang; Jin-Hong Ahn	cord the attached original documents or copy thereof. 2. Name and address of receiving party(ies): Name: <u>Hynix Semiconductor Inc.</u>
Additional name(s) of conveying party(les) attached? No Yes Noture of Conveyance: Assignment Merger Security Agreement Change of Name Other Execution Date: 12/17/2004	Internal Address:
4. Application number(s) or patent number(s): If this document is being filed together with a new appli A. Patent Application No.(s) 11/038,861 Additional numbers atta	B. Patent No.(s)
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Blakely, Sokoloff, Taylor & Zafinan LLP Internal Address:	7. Total Fee (37 CFR 3.41) <u>\$ 40.00</u> ☐ Enclosed ☑ Authorized to be charged to deposit account
Street Address: 12400 Wilshire Boulevard 7th Floor City: Los Angeles State: CA ZIP: 90025	Deposit Account Number: 02-2666 (Attach duplicate copy of this page if paying by deposit account)
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Statement and signature. To the best of my knowledge and belief, the foregoing is true and cor	rect and any attached copy is a true copy of the original document.
Eric S. Hyman Name of Person Signing Total number of pages including cover si	Signature Date Luly 18, 2005 Date

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 Mail Stop Assignment Recordation Services
 Director of the US Patent and Trademark Office
 P.O. Box 1450
 Alexandria, VA 22313-1450

Docket No. 51876P794

Jul-29-05

<u>ASSIGNMENT</u>

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

KANG, Hee-Bok / AHN, Jin-Hong
Hereby sells, assigns, and transfers to:
Hynix Semiconductor, Inc.
a corporation of Republic of Korea, having a principal place of business at:
San 136-1, Ami-ri, Bubal-eub, Ichon-shi, Kyoungki-do 467-860, Republic of Korea ("Assignee"), and its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent,
which has been executed by the undersigned concurrently herewith,
] which was filed and assigned Serial No
and is entitled: SEMICONDUCTOR MEMORY DEVICE FOR LOW POWER SYSTEM
and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all oth applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application;
Agree that said Assignee may apply for and receive Letters Patent for said improvements in own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and other patent applications on any and all said improvements; execute all rightful oaths, assignment owners of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history

its ď ts thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 12.19 , 2004	Kang Hee Bok
	Name: KANG, Hee-Bok
Date: 12 - 17, 200 \(\frac{1}{2} - 17 \)	Sh Tilly
	Name: AHN, Jin-Hong

PATENT REEL: 016592 FRAME: 0443